

| # | Layer | Thickness | Description | Dk | Df | Note |
|---------------------------------|---------------|-----------|----------------------|-----|-------|---------------------|
| | Top Solder | 0.015mm | Soldermask IPC-SM840 | 3,5 | 0,028 | used on rigid parts |
| 1 | Top Side | 0.045mm | ED Copper + plating | | | |
| | | 0.220mm | Prepreg IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 2 | Inner Layer 1 | 0.017mm | ED Base Copper | | | |
| | | 0.150mm | Core IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 3 | Inner Layer 2 | 0.017mm | ED Base Copper | | | |
| | | 0.220mm | Prepreg IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 4 | Inner Layer 3 | 0.017mm | ED Base Copper | | | |
| | | 0.150mm | Core IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 5 | Inner Layer 4 | 0.017mm | ED Base Copper | | | |
| | | 0.220mm | Prepreg IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 6 | Inner Layer 5 | 0.017mm | ED Base Copper | | | |
| | | 0.150mm | Core IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 7 | Inner Layer 6 | 0.017mm | ED Base Copper | | | |
| | | 0.220mm | Prepreg IPC-4101/21 | 3,9 | 0,02 | FR-4.0 |
| 8 | Bottom Side | 0.045mm | ED Copper + plating | | | |
| | Bottom Solder | 0.015mm | Soldermask IPC-SM840 | 3,5 | 0,028 | used on rigid parts |
| Total thickness: 1.552mm | | | | | | |

notes:

Final copper thickness according to IPC-6012

Please regard to our sectional design rules:
▶ www.we-online.com

BASIC8_ML8_1,55_17

PCB Thickness Tolerance: ± 10%

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|----------|--|----------|---------------|
| customer | | created | |
| pcb name | | approved | |
| engineer | | format | A4, landscape |
| date | | | |

Template Revision: 07/2020 by Andreas Schilpp / Michael Kress / Werner Öchslen

